

	A	B	C	D	E
1	<div>Top Copper (Scale 1:1.25)</div>			<div>FABRICATION NOTES:</div> <div>Fabricate per IPC-6011 &amp; IPC-6012 CLASS 2</div> <div>Inspect per IPC-A-600 CLASS 2</div> <div>Test per IPC-TM-650</div> <div><div><div>* PCB has 6 copper layers</div><div>* Copper thicknesses are finished and include base foil plus Cu plating on plated layers.</div><div>* PCB thickness: please refer to the Layer Stack Legend</div><div>* Min. trace width/clearance: 4/4mil</div><div>* Min. hole drill/ring: 8mil/16mil</div><div>* All vias-in-pad shall be plugged and plated over (VIPPO)</div><div>* Soldermask gang relief is allowed for pads in same footprint, if footprint is NSMD.</div><div>* Silkscreen, non-conductive epoxy ink, color: white</div><div>* Remove slikscreen as needed to prevent ink on any exposed copper</div><div>* Surface finish: ENIG</div><div>* Hole dimensions are finished size, +/-3mil</div><div>* Linear board dimension tolerance: +/-10mil</div><div>* Bow, twist, warp not to exceed 0.75% of greatest diagonal span</div><div>* PCB shall be UL Recognized printed wiring board (ZPMV2), minimum flammability rating 94V-0</div><div>* PCB shall be marked with fabricator company or trade name, UL mark, and date code using legend ink on secondary side</div><div>* All PCBs shall be electrically tested for opens and shorts per gerber. Test marking shall be marked on secondard side.</div><div>* GM1 shall be used as PCB outline GKO can be ignored.</div></div><div>Fabricator shall panelize the PCB using mouse bites and tab routing. V-scoring not allowed.</div><div>Controlled impedance differential pairs shall be within +/-10% of target impedance. See sheets below for more detail.</div></div>	
	<div>Signal Layer 3 (Scale 1:1.25)</div>				
2	<div>Signal Layer 1 (Scale 1:1.25)</div>				
	<div>Signal Layer 4 (Scale 1:1.25)</div>				
3	<div>Signal Layer 2 (Scale 1:1.25)</div>			<div><div>Title: <b>BC2087</b></div><div>Number: D2088000      Revision: R3M1 E3</div><div>Date: 08/06/2023      Sheet: 1 of 4</div><div>Drawn by: Boris Chou / Blaz Kvas</div></div> <div><div>LUXonis</div><div>PROPRIETARY AND CONFIDENTIAL</div><div>THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF LUXONIS HOLDING CORPORATION. ANY REPRODUCTION IN PART OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION IS PROHIBITED.</div></div>	
4	<div>Bottom Copper (Scale 1:1.25)</div>				
	A	B	C	D	E

## Drill Table

Symbol	Count	Hole Size	Plated	Hole Tolerance
✱	32	7.95mil(0.202mm)	Plated	
◆	550	8.00mil(0.203mm)	Plated	
◎	311	10.00mil(0.254mm)	Plated	
⊕	1	11.81mil(0.300mm)	Plated	
⊗	14	15.75mil(0.400mm)	Plated	
✳	4	23.62mil(0.600mm)	Plated	
◇	4	31.50mil(0.800mm)	Plated	
✳	14	35.43mil(0.900mm)	Plated	
✳	4	40.16mil(1.020mm)	Plated	
⊗	1	62.99mil(1.600mm)	Non-Plated	
○	1	62.99mil(1.600mm)	Plated	
☆	2	66.93mil(1.700mm)	Plated	
□	3	78.74mil(2.000mm)	Plated	
A	6	86.61mil(2.200mm)	Plated	
B	4	90.55mil(2.300mm)	Plated	
▽	2	118.11mil(3.000mm)	Plated	
✱	2	125.98mil(3.200mm)	Plated	+/-0.00mil(0.000mm)
955 Total				

## Layer Stack Legend

Layer	Thickness	Type	Gerber	Df	Dk
Top Overlay		Legend	GTO		
Top Mask	0.59mil(0.015mm)	Solder Mask	GTS		3,8
Top Copper	1.38mil(0.035mm)	Signal	GTL		
	3.94mil(0.100mm)	Dielectric			4,05
Signal Layer 1	0.69mil(0.018mm)	Signal	G1		
	22.24mil(0.565mm)	Dielectric			4,5
Signal Layer 2	0.69mil(0.018mm)	Signal	G2		
	5.00mil(0.127mm)	Dielectric			4,25
Signal Layer 3	0.69mil(0.018mm)	Signal	G3		
	22.24mil(0.565mm)	Dielectric			4,5
Signal Layer 4	0.69mil(0.018mm)	Signal	G4		
	3.94mil(0.100mm)	Dielectric			4,05
Bottom Copper	1.38mil(0.035mm)	Signal	GBL		
Bottom Mask	0.59mil(0.015mm)	Solder Mask	GBS		3,8
Bottom Overlay		Legend	GBO		
Total thickness: 64.06mil(1.627mm)					

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A

B

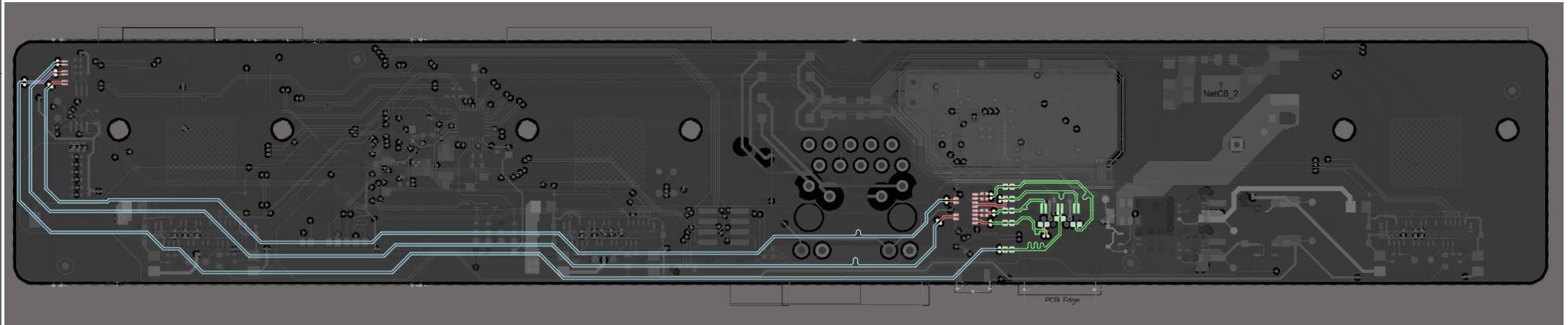
C

D

E

90 OHM (+/-10%) DIFF PAIRS

USB differential pairs



Transmission Line Structure Table

Impedance Id	Target Impedance	Calculated Impedance	Trace layer	Wide Trace Width	Gap	Reference layers	Clearance	Target Tolerance
1	100	100.02	Top Copper	5.12mil	7.67mil	Signal Layer 1	5.00mil	10%
2	90	92.83	Top Copper	5.12mil	5.12mil	Signal Layer 1	5.00mil	10%
3	100	99.98	Signal Layer 2	5.12mil	10.52mil	Signal Layer 1,Signal Layer 3	0.00mil	10%
4	90	89.97	Signal Layer 2	5.17mil	5.89mil	Signal Layer 1,Signal Layer 3	0.00mil	10%
5	90	90.62	Signal Layer 4	4.33mil	5.51mil	Signal Layer 3,Bottom Copper	0.00mil	10%
6	100	100.02	Bottom Copper	5.12mil	7.67mil	Signal Layer 4	5.00mil	10%
7	90	92.83	Bottom Copper	5.12mil	5.12mil	Signal Layer 4	5.00mil	10%

Title: **BC2087**

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A

B

C

D

E

A

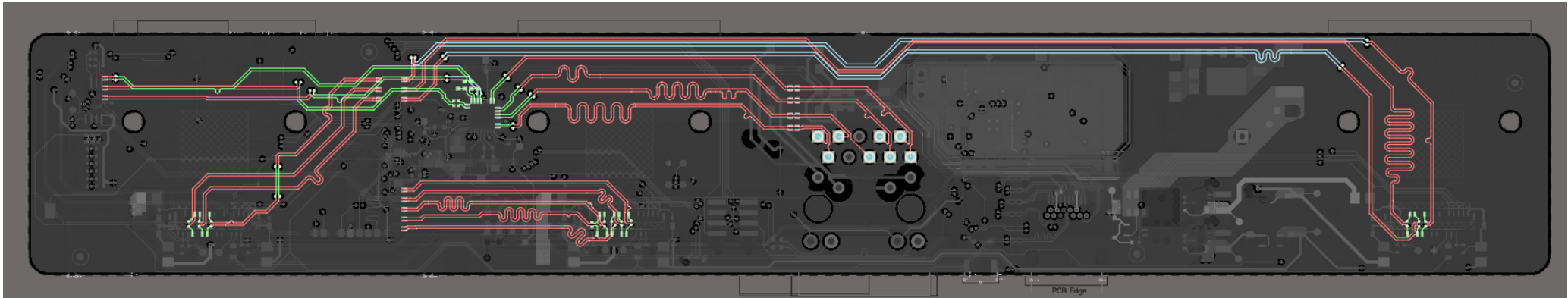
B

C

D


E

100 OHM (+/-10%) DIFF PAIRS



Transmission Line Structure Table

Impedance Id	Target Impedance	Calculated Impedance	Trace layer	Wide Trace Width	Gap	Reference layers	Clearance	Target Tolerance
1	100	100.02	Top Copper	5.12mil	7.67mil	Signal Layer 1	5.00mil	10%
3	100	99.98	Signal Layer 2	5.12mil	10.52mil	Signal Layer 1,Signal Layer 3	0.00mil	10%
6	100	100.02	Bottom Copper	5.12mil	7.67mil	Signal Layer 4	5.00mil	10%

Title: <b>BC2087</b>		
Number: D2088000	Revision: R3M1 E3	
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A

B

C

D

E